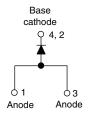


# **High Performance Schottky Rectifier, 10 A**





PRODUCT SUMMARY				
Package	D-PAK (TO-252AA)			
I <sub>F(AV)</sub>	10 A			
$V_{R}$	45 V			
V <sub>F</sub> at I <sub>F</sub>	0.57 V			
I <sub>RM</sub>	15 mA at 125 °C			
T <sub>J</sub> max.	175 °C			
Diode variation	Single die			
E <sub>AS</sub>	20 mJ			

### **FEATURES**

- Low forward voltage drop
- Guard ring for enhanced ruggedness and long term reliability



- Popular D-PAK outline
- · Small foot print, surface mountable
- High frequency operation
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

### **DESCRIPTION**

The VS-STPS1045B-M3 surface mount Schottky rectifier has been designed for applications requiring low forward drop and small foot prints on PC board. Typical applications are in disk drives, switching power supplies, converters, freewheeling diodes, battery charging, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS						
SYMBOL	CHARACTERISTICS	VALUES	UNITS			
I <sub>F(AV)</sub>	Rectangular waveform	10	A			
V <sub>RRM</sub>		45	V			
I <sub>FSM</sub>	t <sub>p</sub> = 5 μs sine	390	Α			
V <sub>F</sub>	10 A <sub>pk</sub> , T <sub>J</sub> = 125 °C	0.57	V			
T <sub>J</sub>	Range	-40 to +175	°C			

VOLTAGE RATINGS						
PARAMETER SYMBOL VS-STPS1045B-M3 UNITS						
Maximum DC reverse voltage	$V_{R}$	45	V			
Maximum working peak reverse voltage	ing peak reverse voltage V <sub>RWM</sub> 45					

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST COND	TEST CONDITIONS		UNITS	
Maximum average forward current See fig. 5	I <sub>F(AV)</sub>	50 % duty cycle at T <sub>C</sub> = 151 °C, rectangular waveform		10		
Maximum peak one cycle non-repetitive surge current	1	5 μs sine or 3 μs rect. pulse Following any rated load condition and with rated		390	А	
See fig. 7	IFSM	10 ms sine or 6 ms rect. pulse	V <sub>RRM</sub> applied	75		
Non-repetitive avalanche energy	E <sub>AS</sub>	T <sub>J</sub> = 25 °C, I <sub>AS</sub> = 3.0 A, L = 4.40 mH		20	mJ	
Repetitive avalanche current	I <sub>AR</sub>	Current decaying linearly to zero in 1 µs Frequency limited by T <sub>J</sub> maximum V <sub>A</sub> = 1.5 x V <sub>R</sub> typical		3.0	Α	



ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST COND	VALUES	UNITS		
		10 A	T <sub>.1</sub> = 25 °C	0.63		
Maximum forward voltage drop	V <sub>FM</sub> <sup>(1)</sup>	20 A	11=23 0	0.84	V	
See fig. 1	VFM (')	10 A	T 405.00	0.57		
		20 A	T <sub>J</sub> = 125 °C	0.72		
Maximum reverse leakage current	I <sub>RM</sub> <sup>(1)</sup>	T <sub>J</sub> = 25 °C	V <sub>R</sub> = Rated V <sub>R</sub>	0.2	A	
See fig. 2	IRM (")	T <sub>J</sub> = 125 °C		15	mA	
Typical junction capacitance	C <sub>T</sub>	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz), 25 °C		760	pF	
Typical series inductance	L <sub>S</sub>	Measured lead to lead 5 mm from package body		5.0	nΗ	
Maximum voltage rate of change	dV/dt	Rated V <sub>R</sub>		10 000	V/µs	

#### Note

 $<sup>^{(1)}\,</sup>$  Pulse width < 300 µs, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS		
Maximum junction and storage temperature range	T <sub>J</sub> <sup>(1)</sup> , T <sub>Stg</sub>		-40 to +175	°C		
Maximum thermal resistance, junction to case	R <sub>thJC</sub>	DC operation See fig. 4	3.0	°C/W		
Maximum thermal resistance, junction to ambient	R <sub>thJA</sub>		50	C/VV		
Approximate weight			0.3	g		
Approximate weight			0.01	OZ.		
Marking device		Case style D-PAK (similar to TO-252AA)	STPS10	045B		

#### Note

(1) 
$$\frac{dP_{tot}}{dT_J} < \frac{1}{R_{thJA}}$$
 thermal runaway condition for a diode on its own heatsink

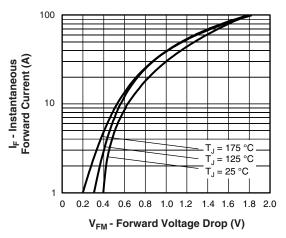


Fig. 1 - Maximum Forward Voltage Drop Characteristics

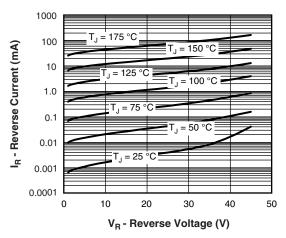


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

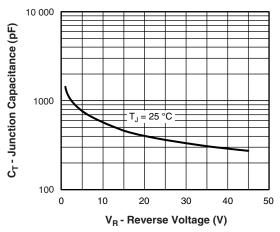


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

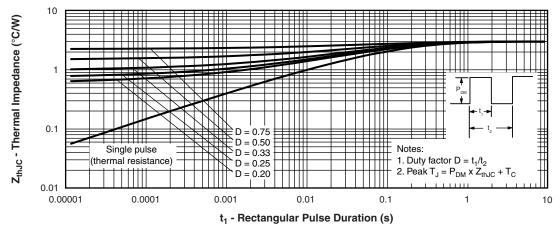


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

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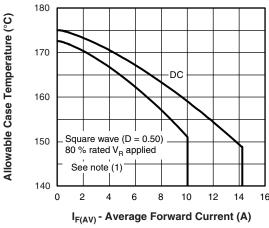


Fig. 5 - Maximum Allowable Case Temperature vs.
Average Forward Current

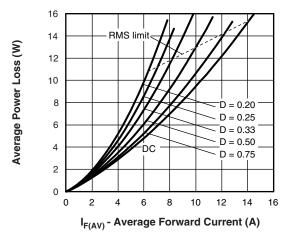


Fig. 6 - Forward Power Loss Characteristics

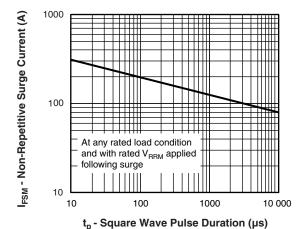


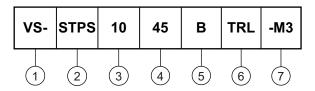
Fig. 7 - Maximum Non-Repetitive Surge Current

### Note



### **ORDERING INFORMATION TABLE**

**Device code** 



1 - Vishay Semiconductors product

2 - Schottky STPS series

3 - Current rating (10 A)

- Voltage rating (45 = 45 V)

5 - B = Essential part number

6 - • None = tube

• TR = tape and reel

• TRL = tape and reel (left oriented)

• TRR = tape and reel (right oriented)

7 - Environmental digit:

-M3 = halogen-free, RoHS-compliant and terminations lead (Pb)-free

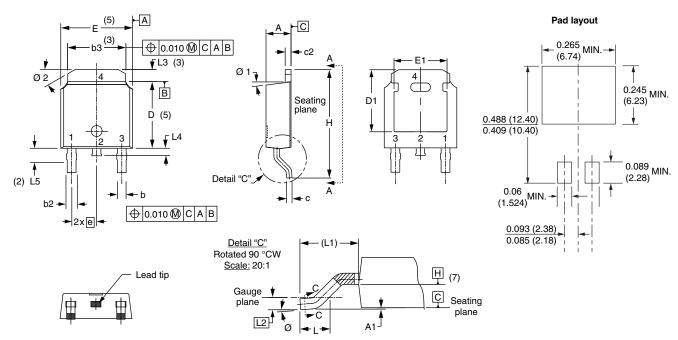
ORDERING INFORMATION (Example)						
PREFERRED P/N QUANTITY PER T/R MINIMUM ORDER QUANTITY PACKAGING DESCRIP						
VS-STPS1045B-M3	75	3000	Antistatic plastic tube			
VS-STPS1045BTR-M3	2000	2000	13" diameter reel			
VS-STPS1045BTRL-M3	3000	3000	13" diameter reel			
VS-STPS1045BTRR-M3	3000	3000	13" diameter reel			

LINKS TO RELATED DOCUMENTS				
Dimensions <u>www.vishay.com/doc?95627</u>				
Part marking information	www.vishay.com/doc?95176			
Packaging information	www.vishay.com/doc?95033			



# D-PAK (TO-252AA) "M"

### **DIMENSIONS** in millimeters and inches



SYMBOL	MILLIN	IETERS	INCHES		NOTES
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
Α	2.18	2.39	0.086	0.094	
A1	-	0.13	-	0.005	
b	0.64	0.89	0.025	0.035	
b2	0.76	1.14	0.030	0.045	
b3	4.95	5.46	0.195	0.215	3
С	0.46	0.61	0.018	0.024	
c2	0.46	0.89	0.018	0.035	
D	5.97	6.22	0.235	0.245	5
D1	5.21	-	0.205	-	3
Е	6.35	6.73	0.250	0.265	5
E1	4.32	-	0.170	-	3

SYMBOL	MILLIN	IETERS	INCHES		NOTES
OTIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
е	2.29 BSC		0.090	BSC	
Н	9.40	10.41	0.370	0.410	
L	1.40	1.78	0.055	0.070	
L1	2.74	2.74 BSC		REF.	
L2	0.51	BSC	0.020 BSC		
L3	0.89	1.27	0.035	0.050	3
L4	-	1.02	-	0.040	
L5	1.14	1.52	0.045	0.060	2
Ø	0°	10°	0°	10°	
Ø1	0°	15°	0°	15°	
Ø2	25°	35°	25°	35°	

#### Notes

- (1) Dimensioning and tolerancing as per ASME Y14.5M-1994
- (2) Lead dimension uncontrolled in L5
- (3) Dimension D1, E1, L3 and b3 establish a minimum mounting surface for thermal pad
- (4) Section C C dimension apply to the flat section of the lead between 0.13 and 0.25 mm (0.005 and 0.10") from the lead tip
- (5) Dimension D, and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (6) Dimension b1 and c1 applied to base metal only
- (7) Datum A and B to be determined at datum plane H
- (8) Outline conforms to JEDEC® outline TO-252AA



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